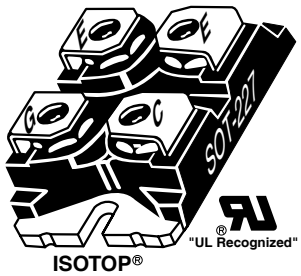
APT40GP90J

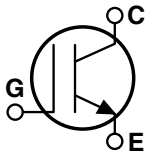
900V

POWER MOS 7® IGBT



The POWER MOS 7® IGBT is a new generation of high voltage power IGBTs. Using Punch Through Technology this IGBT is ideal for many high frequency, high voltage switching applications and has been optimized for high frequency switchmode power supplies.

- **Low Conduction Loss**
- **Low Gate Charge**
- **Ultrafast Tail Current shutoff**
- **SSOA Rated**



MAXIMUM RATINGS All Ratings: T_C = 25°C unless otherwise specified.

Symbol	Parameter	APT40GP90J	UNIT
V_{CES}	Collector-Emitter Voltage	900	Volts
V_{GE}	Gate-Emitter Voltage	±20	
V_{GEM}	Gate-Emitter Voltage Transient	±30	
I_{C1}	Continuous Collector Current @ T_C = 25°C	68	Amps
I_{C2}	Continuous Collector Current @ T_C = 110°C	32	
I_{CM}	Pulsed Collector Current ① @ T_C = 150°C	160	
SSOA	Switching Safe Operating Area @ T_J = 150°C	160A @ 900V	
P_D	Total Power Dissipation	284	Watts
T_J,T_{STG}	Operating and Storage Junction Temperature Range	-55 to 150	°C
T_L	Max. Lead Temp. for Soldering: 0.063" from Case for 10 Sec.	300	

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic / Test Conditions	MIN	TYP	MAX	UNIT
BV_{CES}	Collector-Emitter Breakdown Voltage (V_{GE} = 0V, I_C = 250µA)	900			Volts
$V_{GE(TH)}$	Gate Threshold Voltage (V_{CE} = V_{GE}, I_C = 1mA, T_j = 25°C)	3	4.5	6	
$V_{CE(ON)}$	Collector-Emitter On Voltage (V_{GE} = 15V, I_C = 40A, T_j = 25°C)		3.2	3.9	
	Collector-Emitter On Voltage (V_{GE} = 15V, I_C = 40A, T_j = 125°C)		2.7		
I_{CES}	Collector Cut-off Current (V_{CE} = V_{CES}, V_{GE} = 0V, T_j = 25°C) ②			250	µA
	Collector Cut-off Current (V_{CE} = V_{CES}, V_{GE} = 0V, T_j = 125°C) ②			1000	
I_{GES}	Gate-Emitter Leakage Current (V_{GE} = ±20V)			±100	nA

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

APT Website - http://www.advancedpower.com

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DYNAMIC CHARACTERISTICS

APT40GP90J

Symbol	Characteristic	Test Conditions	MIN	TYP	MAX	UNIT
C_{ies}	Input Capacitance	**Capacitance**		3300		pF
C_{oes}	Output Capacitance	V_{GE} = 0V, V_{CE} = 25V		325		
C_{res}	Reverse Transfer Capacitance	f = 1 MHz		35		
V_{GEP}	Gate-to-Emitter Plateau Voltage	**Gate Charge**		7.5		V
Q_g	Total Gate Charge ③	V_{GE} = 15V		145		nC
Q_{ge}	Gate-Emitter Charge	V_{CE} = 450V		22		
Q_{gc}	Gate-Collector ("Miller") Charge	I_C = 40A		55		
SSOA	Switching Safe Operating Area	T_J = 150°C, R_G = 5Ω, V_{GE} = 15V, L = 100µH, V_{CE} = 900V	160			A
$t_{d(on)}$	Turn-on Delay Time	**Inductive Switching (25°C)**		16		ns
t_r	Current Rise Time	V_{CC} = 600V		27		
$t_{d(off)}$	Turn-off Delay Time	V_{GE} = 15V		75		
t_f	Current Fall Time	I_C = 40A		60		
E_{on1}	Turn-on Switching Energy ④	R_G = 5Ω		TBD		µJ
E_{on2}	Turn-on Switching Energy (Diode) ⑤	T_J = +25°C		1415		
E_{off}	Turn-off Switching Energy ⑥			825		
$t_{d(on)}$	Turn-on Delay Time	**Inductive Switching (125°C)**		16		ns
t_r	Current Rise Time	V_{CC} = 600V		27		
$t_{d(off)}$	Turn-off Delay Time	V_{GE} = 15V		110		
t_f	Current Fall Time	I_C = 40A		105		
E_{on1}	Turn-on Switching Energy ④	R_G = 5Ω		TBD		µJ
E_{on2}	Turn-on Switching Energy (Diode) ⑤	T_J = +125°C		2370		
E_{off}	Turn-off Switching Energy ⑥			1505		

THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Characteristic	MIN	TYP	MAX	UNIT
$R_{\Theta JC}$	Junction to Case (IGBT)			.44	°C/W
$R_{\Theta JC}$	Junction to Case (DIODE)			N/A	
W_T	Package Weight			21.9	gm

① Repetitive Rating: Pulse width limited by maximum junction temperature.

② For Combi devices, I_{ces} includes both IGBT and FRED leakages

③ See MIL-STD-750 Method 3471.

④ E_{on1} is the clamped inductive turn-on-energy of the IGBT only, without the effect of a commutating diode reverse recovery current adding to the IGBT turn-on loss. (See Figure 24.)

⑤ E_{on2} is the clamped inductive turn-on energy that includes a commutating diode reverse recovery current in the IGBT turn-on switching loss. (See Figures 21, 22.)

⑥ E_{off} is the clamped inductive turn-off energy measured in accordance with JEDEC standard JESD24-1. (See Figures 21, 23.)

APT Reserves the right to change, without notice, the specifications and information contained herein.

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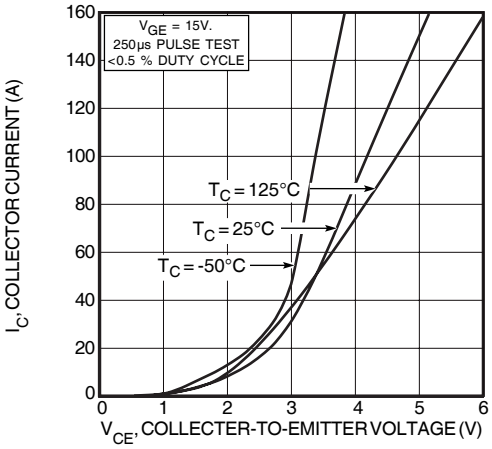


FIGURE 1, Output Characteristics(V_{GE} = 15V)

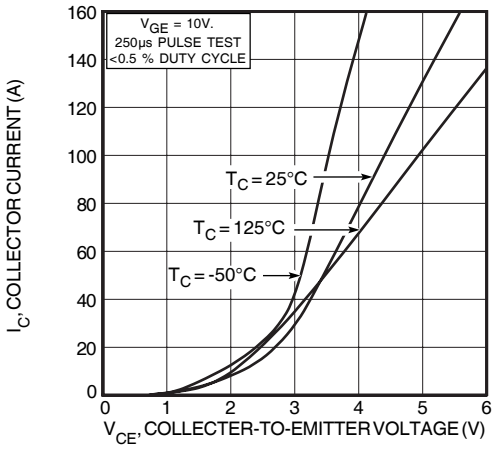


FIGURE 2, Output Characteristics (V_{GE} = 10V)

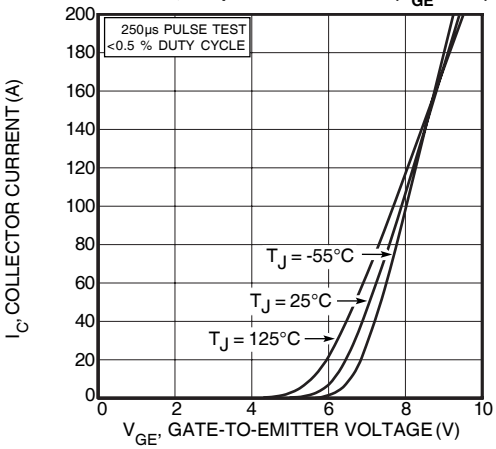


FIGURE 3, Transfer Characteristics

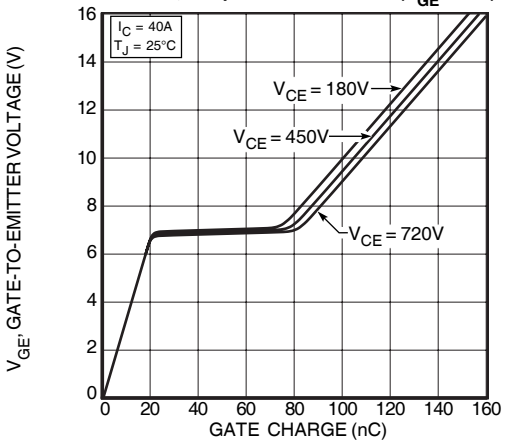


FIGURE 4, Gate Charge

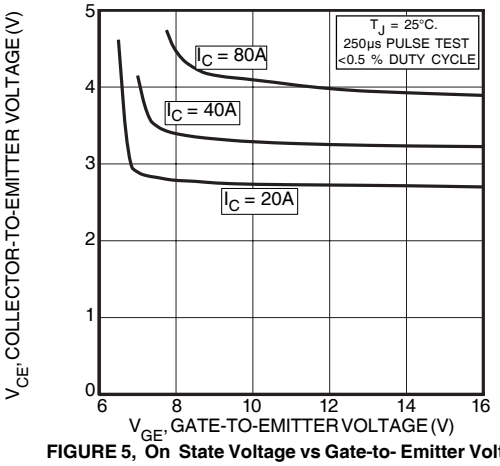


FIGURE 5, On State Voltage vs Gate-to- Emitter Voltage

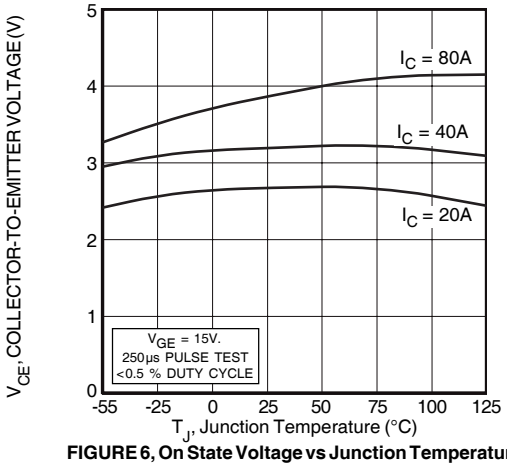


FIGURE 6, On State Voltage vs Junction Temperature

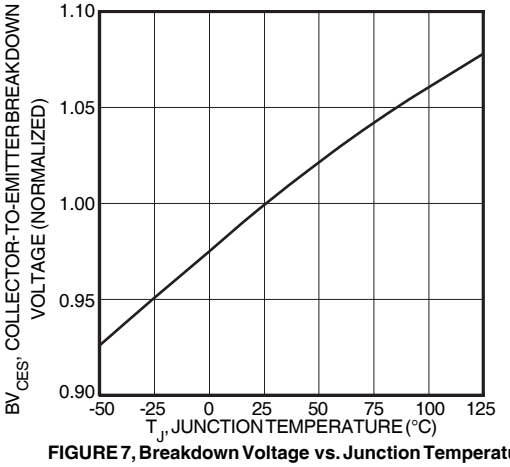


FIGURE 7, Breakdown Voltage vs. Junction Temperature

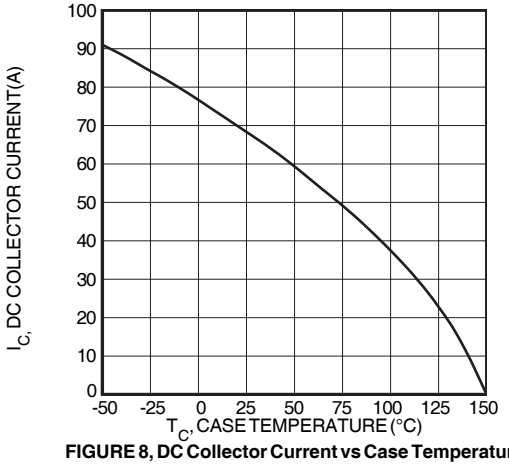


FIGURE 8, DC Collector Current vs Case Temperature

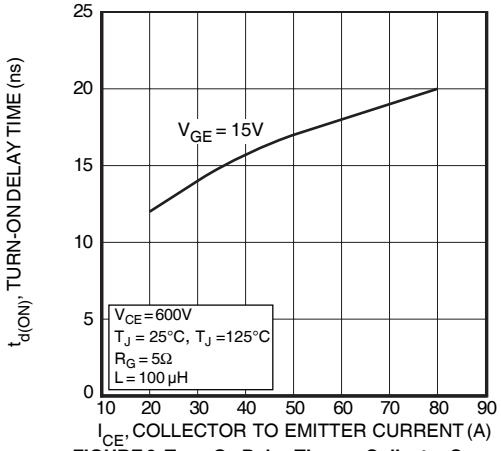


FIGURE 9, Turn-On Delay Time vs Collector Current

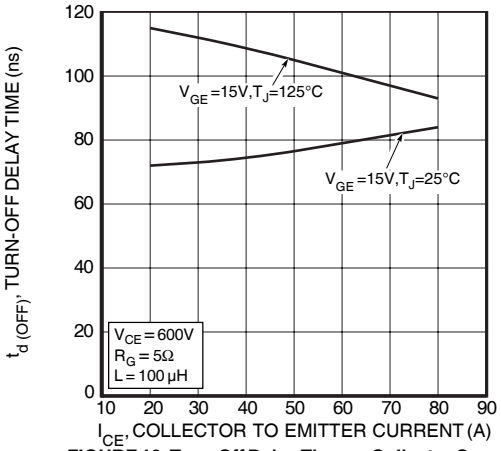


FIGURE 10, Turn-Off Delay Time vs Collector Current

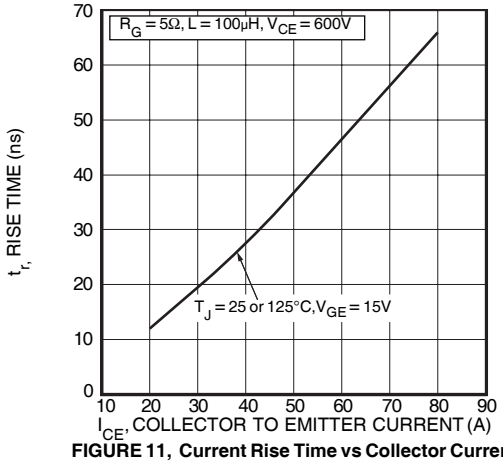


FIGURE 11, Current Rise Time vs Collector Current

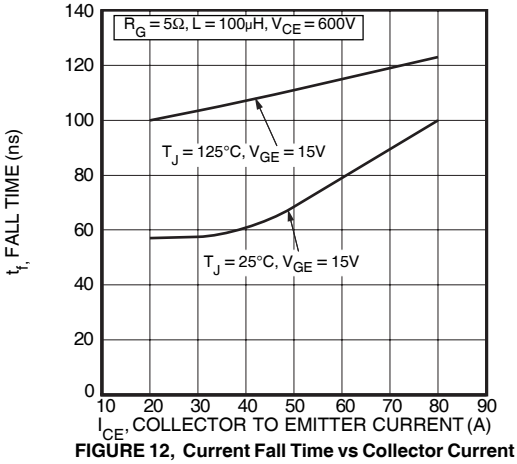


FIGURE 12, Current Fall Time vs Collector Current

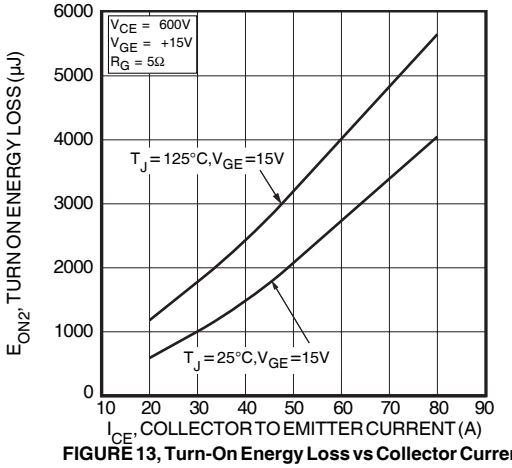


FIGURE 13, Turn-On Energy Loss vs Collector Current

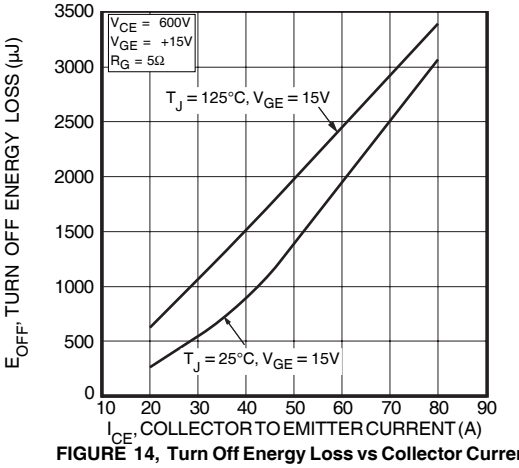


FIGURE 14, Turn Off Energy Loss vs Collector Current

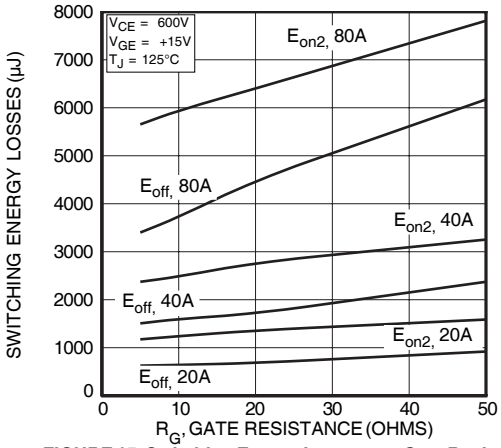


FIGURE 15, Switching Energy Losses vs. Gate Resistance

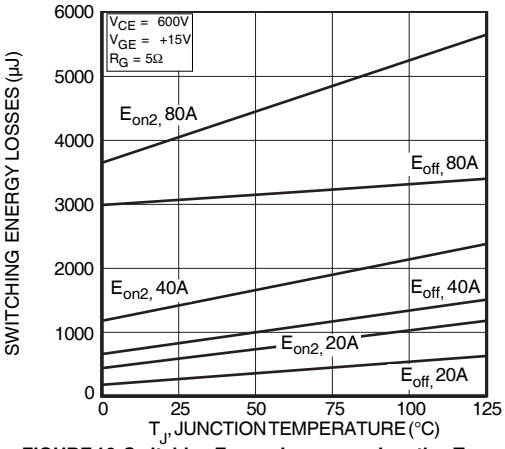


FIGURE 16, Switching Energy Losses vs Junction Temperature

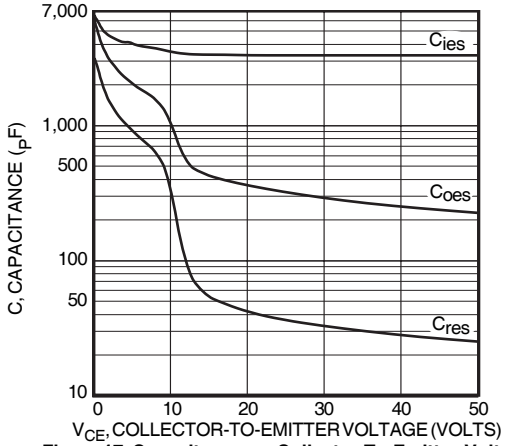


Figure 17, Capacitance vs Collector-To-Emitter Voltage

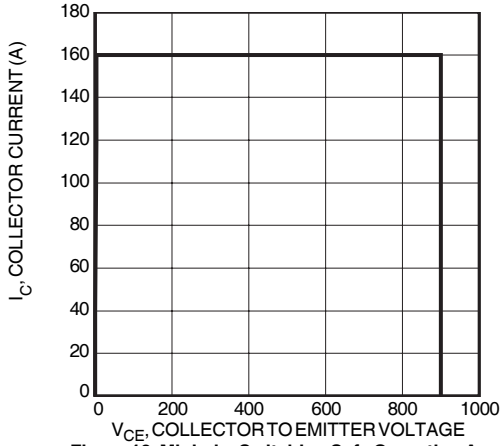


Figure 18, Minimim Switching Safe Operating Area

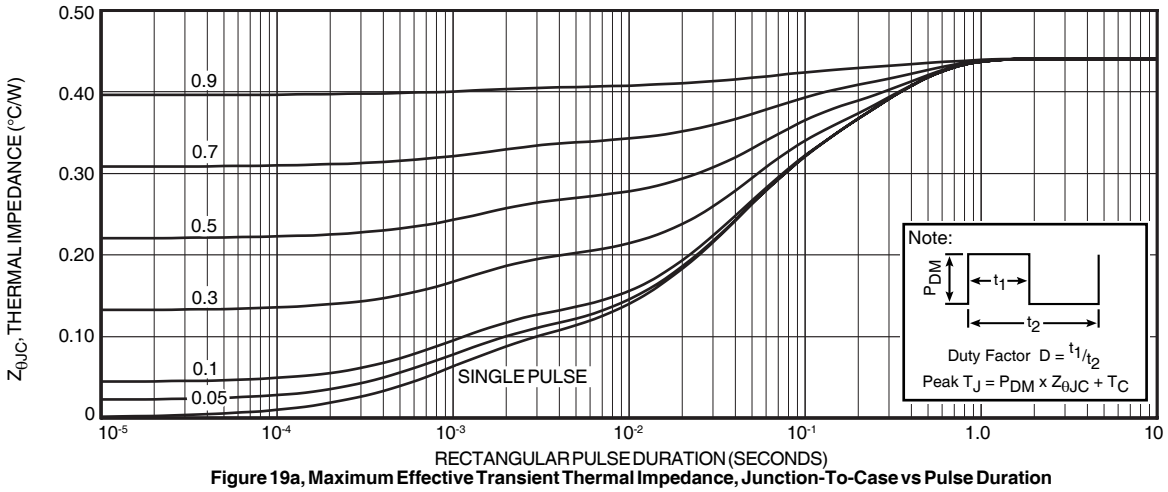


Figure 19a, Maximum Effective Transient Thermal Impedance, Junction-To-Case vs Pulse Duration

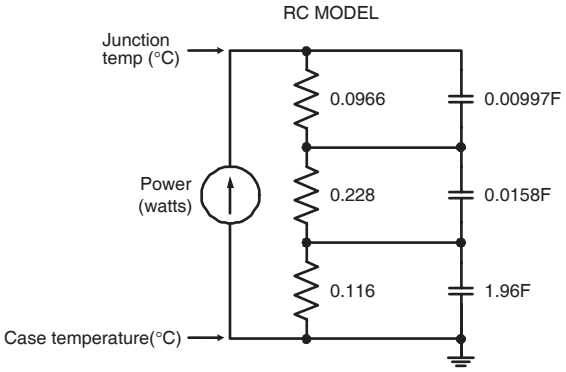
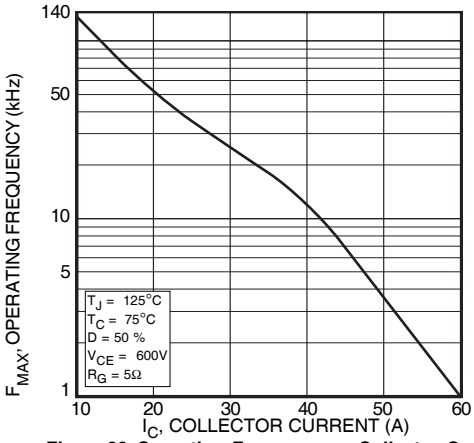


FIGURE 19b, TRANSIENT THERMAL IMPEDANCE MODEL



$$F_{max} = \min(f_{max1}, f_{max2})$$

$$f_{max1} = \frac{0.05}{t_{d(on)} + t_r + t_{d(off)} + t_f}$$

$$f_{max2} = \frac{P_{diss} - P_{cond}}{E_{on2} + E_{off}}$$

$$P_{diss} = \frac{T_j - T_C}{R_{\theta JC}}$$

Figure 20, Operating Frequency vs Collector Current

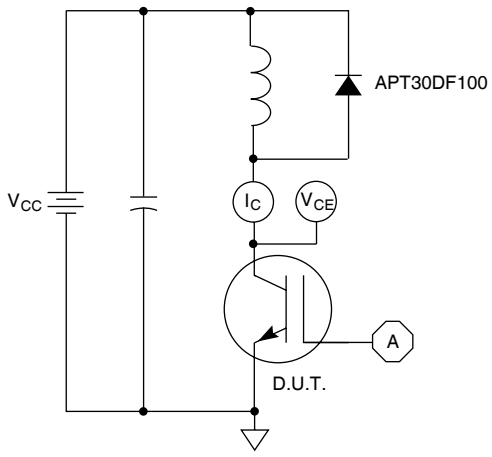


Figure 21, Inductive Switching Test Circuit

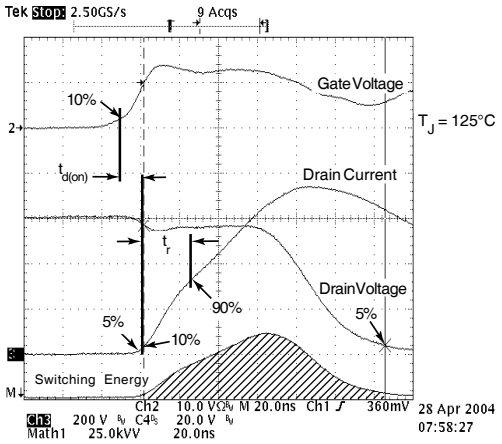


Figure 22, Turn-on Switching Waveforms and Definitions

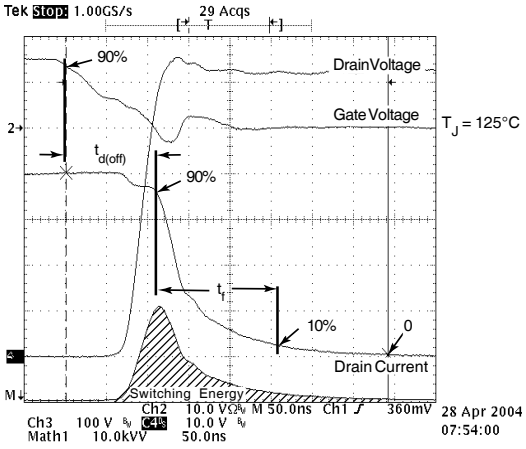


Figure 23, Turn-off Switching Waveforms and Definitions

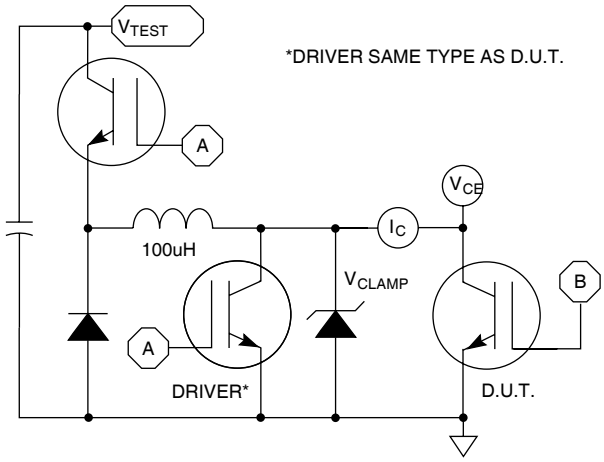
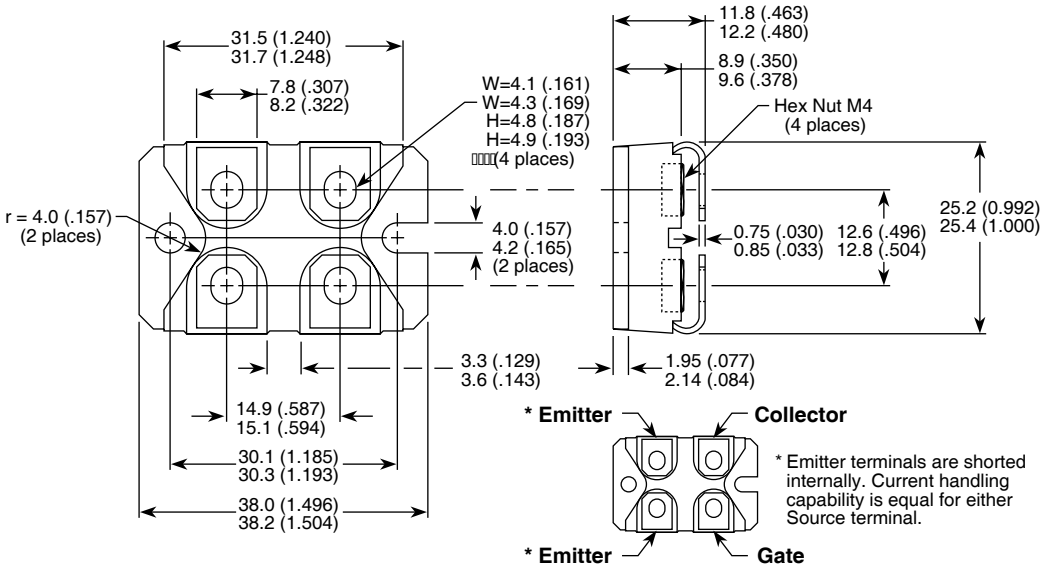


Figure 24, E_{ON1} Test Circuit

SOT-227 (ISOTOP®) Package Outline



Dimensions in Millimeters and (Inches)

ISOTOP® is a Registered Trademark of SGS Thomson. APT's products are covered by one or more of U.S.patents 4,895,810 5,045,903 5,089,434 5,182,234 5,019,522 5,262,336 6,503,786 5,256,583 4,748,103 5,283,202 5,231,474 5,434,095 5,528,058 and foreign patents. US and Foreign patents pending. All Rights Reserved.